### 502193206 01/14/2013

# PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Kee Hae KWON	01/09/2013
Jin Hwa CHUNG	01/09/2013
Jin Seong LEE	01/09/2013
Man Suk KIM	01/09/2013
Kwang Soo PARK	01/09/2013
Ja Kwan KOO	01/09/2013

### **RECEIVING PARTY DATA**

Name:	Cheil Industries Inc.	
Street Address:	290 Gongdan-dong	
Internal Address:	Gumi-si, Gyeongsangbuk-do	
City:	Gumi-si	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	730-710	

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13740335

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 1224.079

REEL: 029619 FRAME: 0705

**PATENT** 

DP \$40,00 13740335

NAME OF SUBMITTER:	Melissa B. Pendleton
Total Attachments: 5 source=AssignmentsUSPTO#page1.tif source=AssignmentsUSPTO#page2.tif source=AssignmentsUSPTO#page3.tif source=AssignmentsUSPTO#page4.tif source=AssignmentsUSPTO#page5.tif	

PATENT REEL: 029619 FRAME: 0706 Form PTO-1595 (Rev. 08/05) OMB No. 0651-0027 (exp. 6/30/2008)

RECORDATION FORM COVER SHEET PATENTS ONLY				
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below:				
1. Name of conveying party(ies) Kee Hae KWON Jin Hwa CHUNG Jin Seong LEE Man Suk KIM Kwang Soo PARK	2. Name and address of receiving party(ies) Name: Cheil Industries Inc. Internal Address:			
Ja Kwan KOO Additional name(s) of conveying party(ies) attached?  3. Nature of conveyance/Execution Date(s): Execution Date(s) January 9, 2013	Street Address: 290 Gongdan-dong			
Assignment Merger  Security Agreement Change of Name  Joint Research Agreement  Government Interest Assignment	City: Gumi-si State: Gyeongsangbuk-do			
Executive Order 9424, Confirmatory License Other	Country: South Korea zip: 730-710  Additional name(s) & address(es) attached? Yes X No			
A. Patent Application No.(s) 13/740,335	document is being filed together with a new application.  B. Patent No.(s)  B. Patent No.(s)  Calculation with a new application.			
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1			
Name: Summa, Additon & Ashe, P.A. Internal Address:	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00  Authorized to be charged by credit card  Authorized to be charged to deposit account			
Street Address: 11610 N. Community House Road, Suite 200	Enclosed  None required (government interest not affecting title)			
City: Charlotte	8. Payment Information			
State: NC Zip; 28277-2199	a. Credit Card Last 4 Numbers Expiration Date			
Phone Number: 704-945-6700  Fax Number: 704-945-6735  Email Address:	b. Deposit Account Number  Authorized User Name			
9. Signature: /Melissa B. Pendleton/ Signature Melissa B. Pendleton  Name of Person Signing	January 14, 2013  Date  Total number of pages including cover sheet, attachments, and documents:			

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or malled to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

#### ASSIGNMENT

WHEREAS, I, Kee Hae KWON, a Korean citizen, with a mailing: address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; Jin Hwa CHUNG, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheondong, Uiwang-si, Gyeonggi-do, Republic of Korea; Jin Seong LEE, a -Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; Man Suk KIM, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; Kwang Soo PARK, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; and Ja Kwan KOO, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in Transparent Thermoplastic Resin Composition, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from an international application filed on December 29, 2010, under Serial No. PCT/KR2010/009538, which itself claims priority from a Korean application filed on July 28, 2010, under Serial No. 10-2010-0072920, all applications listed ' above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do, 730-1710, Republic of Korea, Republic of Korea, has acquired the

PATENT

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equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest - and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interestin and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignmentand sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby

request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

As the below named inventor, I hereby declare:

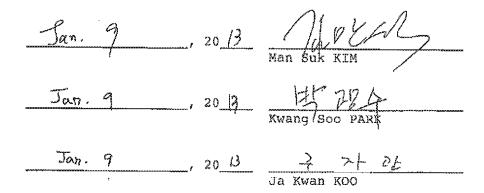
The application for United States Letters Patent being filed concurrently herewith was made or authorized to be made by me.

I believe that I am the original or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in the declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

Jan. 9	, 20_13_	구: 71 bel Kee Hae KWON
Jan. 9	, 20 <u>/3</u>	Jin Hwa CHUNG
Jan. 9	, 20 <u></u>	Jin Seong LEE



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